





2N6292

TO-220 Leaded Plastic Package RoHS compliant

TO-220

COMPLEMENTARY - 2N6107 (PNP)

FEATURES:

1. This product is available in AEC-Q101 Compliant and PPAP Capable also.

Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

APPLICATIONS: General Purpose Amplifier and Switching Applications

ABSOLUTE MAXIMUM RATINGS ($T_a = 25 °C$)

PARAMETER		SYMBOL	VALUE	UNIT
Collector Base Voltage		V _{CBO}	80	V
Collector Emitter Vol	tage	V _{CEO}	70	V
Collector Emitter Vol	tage (R _{BE} = 100Ω)	V _{CER}	80	V
Emitter Base Voltage	9	V _{EBO}	5	V
Collector Current (Pe	eak)	I _{CM}	10	А
Collector Current Co	ntinuous	Ι _C	7	А
Base Current		I _B	3	А
Power Dissipation	T _c =25°C		40	W
	Derating factor above 25ºC	P _D	0.32	W/ºC
	T _a =25°C		2	W
Power Dissipation	Derating factor above 25ºC	P _D	16	mW/ºC
Junction Temperature		T _i	150	°C
Storage Temperature		T _{stg}	- 65 to 150	°C
THERMAL RESIST	NCE	· · ·		•
Junction to Case		R _{θ(j-c)}	3.125	°C/W
Junction to Ambient		R _{θ(j-a)}	62.5	°C/W

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ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

PARAMETE	R	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Collector Cut off Current		I _{CEO}	V _{CE} =60V, I _B =0	-	1	mA
Collector Cut off Curre	Collector Cut off Current		V _{EB(off)} =1.5V; V _{CE} =80V	-	0.1	mA
Collector Cut off Curre	nt	- I _{CEX}	V _{EB(off)} =1.5V; V _{CE} =70V; T _c =150°C	-	2	mA
Emitter Cut off Current		I _{EBO}	V _{EB} =5V, I _C =0	-	1	mA
Collector Emitter (sus)	Voltage	*V _{CEO(sus)}	I _C =100mA, I _B =0	70	-	V
Collector Emitter Saturation		*V _{CE(sat)}	I _C =3A, I _B =0.3A		1	V
Collector Emitter Saturation			I _C =7A, I _B =3.0A	-	3.5	V
Base Emitter on Voltage		*V _{BE(on)}	I _C =2A, V _{CE} =4V		1.5	V
Base Emitter on Voltage			I _C =7A, V _{CE} =4V	-	3	V
DC Current Gain		*h _{FE}	I _C =2A, V _{CE} =4V	30	150	
DC Current Gain			I _C =7A, V _{CE} =4V	2.3	150	
DYNAMIC CHARACT	ERISTIC					
Small Signal Current Gain		h _{fe}	I _C =500mA,V _{CE} =4V, f	20	-	
Output Capacitance		Cob	I _E =0, V _{CB} =10V, f =1 MHz	-	250	pF
ZN6107		f	1 - 500 m A V - 4V	10	-	MHz
Transition frequency	2N6292	f _T I _C =500mA,V _{CE} =4V		4	-	MHz

*Pulse Test : Pulse duration<300µs; Duty cycle<1.5%





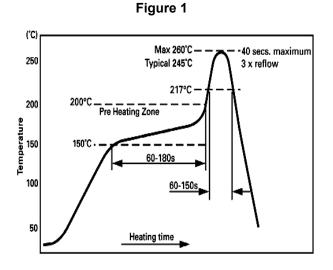
Recommended Reflow Solder Profiles

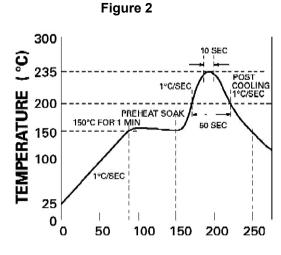
The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

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Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.





TIME (SEC)

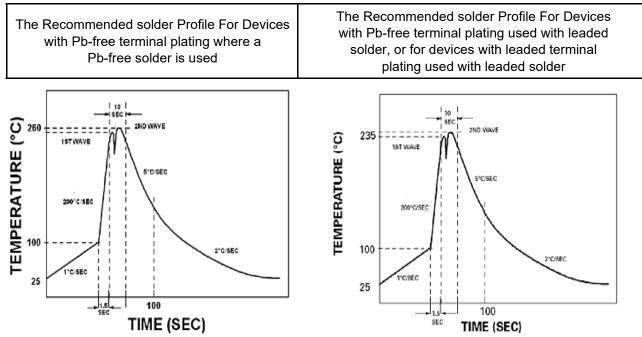
Reflow profiles in tabular form						
Profile Feature Sn-Pb System Pb-Free System						
Average Ramp-Up Rate	~3°C/second	~3°C/second				
Preheat – Temperature Range – Time	150-170°C 60-180 seconds	150-200°C 60-180 seconds				
Time maintained above: – Temperature – Time	200°C 30-50 seconds	217°C 60-150 seconds				
Peak Temperature	235°C	260°C max.				
Time within +0 -5°C of actual Peak	10 seconds	40 seconds				
Ramp-Down Rate	3°C/second max.	6°C/second max.				



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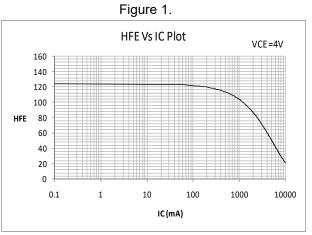
Recommended	Wave Sold	er Profiles
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Wave Profiles in Tabular Form					
Profile Feature	Sn-Pb System	Pb-Free System			
Average Ramp-Up Rate	~200°C/second	~200°C/second			
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec			
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Temp			
Peak Temperature	235°C	260°C max.			
Time within +0 -5°C of actual Peak	10 seconds	10 seconds			
Ramp-Down Rate	5°C/second max.	5°C/second max			





TYPICAL CHARACTERISTICS CURVE



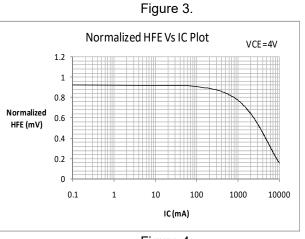
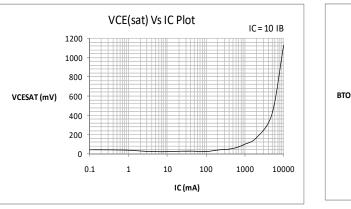
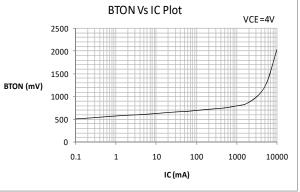


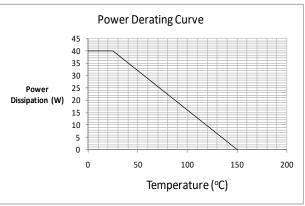
Figure 2.









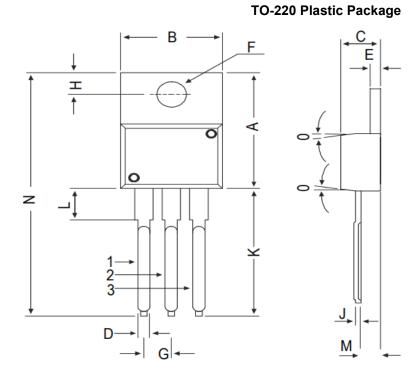


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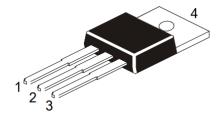


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PACKAGE DETAILS



DIM	MIN	MAX	
Α	14.42	16.51	
В	9.63	10.67	
С	3.56	4.83	
D	_	0.90	
E	1.15	1.50	
F	3.53	4.10	
G	2.29	2.79	
Н	2.54	3.43	
J	0.36	0.61	
K	12.70	14.73	
L	2.80	6.35	
М	2.00	2.92	
N	_	31.24	
0	7 DEG Acti		



Pin Configuration

- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector

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End Pin ±1.5 536.00 13.74 Label Φ Φ Φ Φ Φ \oplus Φ Φ ∉ Ð DEVICE NAME Sr. 32.85 QTY. 50 Pcs./Tube 6.87 Tube Thickness All Dimensions in mm AMMO PACK SIZE Label 0 .538,00 75.0 Activate Win

TO-220 Tube Packing

T & A: Tape and Ammo Pack; T & R: Tape and Reel; Bulk: Loose in Poly Bags; Tube: Tube and Carton; K: 1,000	
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Package / Case Type	Packaging Type	Std. Packing	Inner Carton		Outer Carton			
		Qty	Qty	Size L x W x H	Gross Weight	Qty	Size L x W x H	Gross Weight
				(cm)	(Kg)		(cm)	(Kq)
T0-220	Bulk	1,000	1K	19 x 19 x 8	2.0	10K	46 x 38 x 22	21.6
	Tube	1,000 (50 pcs/tube)	1K	55 x 8 x 10	2.8	10K	55 x 35 x 27	28.3





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Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- \cdot Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- \cdot Avoid condensation.
- $\cdot\,$ Mechanical stress such as vibration and impact shall be avoided.
- $\cdot\,$ The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level					
Level	Time	Condition			
1	Unlimited	≤30 °C / 85% RH			
2	1 Year	≤30 °C / 60% RH			
2a	4 Weeks	≤30 °C / 60% RH			
3	168 Hours	≤30 °C / 60% RH			
4	72 Hours	≤30 °C / 60% RH			
5	48 Hours	≤30 °C / 60% RH			
5a	24 Hours	≤30 °C / 60% RH			
6	Time on Label(TOL)	≤30 °C / 60% RH			





Customer Notes

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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